

# **6-Pin DIP General Purpose Photodarlington Optocoupler**

# 4N29M, 4N30M, 4N32M, 4N33M, H11B1M, TIL113M

#### Description

The 4N29M, 4N30M, 4N32M, 4N33M, H11B1M, and TIL113M have a gallium arsenide infrared emitter optically coupled to a silicon planar photodarlington.

#### **Features**

- High Sensitivity to Low Input Drive Current
- Meets or Exceeds All JEDEC Registered Specifications
- Safety and Regulatory Approvals:
  - ◆ UL1577, 4,170 VAC<sub>RMS</sub> for 1 Minute
  - ◆ DIN-EN/IEC60747-5-5, 850 V Peak Working Insulation Voltage

### **Applications**

- Low Power Logic Circuits
- Telecommunications Equipment
- Portable Electronics
- Solid State Relays
- Interfacing Coupling Systems of Different Potentials and Impedances



PDIP6 CASE 646BX



PDIP6 **S SUFFIX** CASE 646BY



PDIP6 **T SUFFIX** CASE 646BZ

#### MARKING DIAGRAM



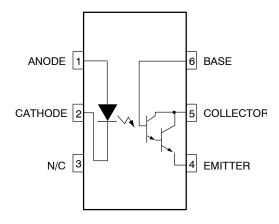
ON

XXXXX = Specific Device Code

= DIN EN/IEC60747-5-5 Option (only appears on component ordered with this option)

Χ = One-Digit Year Code YY = Digit Work Week = Assembly Package Code

### **SCHEMATIC**



#### ORDERING INFORMATION

See detailed ordering and shipping information on page 8 of this data sheet.

**SAFETY AND INSULATION RATINGS** (As per DIN EN/IEC 60747–5–5, this optocoupler is suitable for "safe electrical insulation" only within the safety limit data. Compliance with the safety ratings shall be ensured by means of protective circuits.)

| Parameter   |                       | Characteristics |
|---|-----------------------|-----------------|
| Installation Classifications per DIN VDE 0110/1.89 Table 1, | <150 V <sub>RMS</sub> | I–IV            |
| For Rated Mains Voltage                                     | <300 V <sub>RMS</sub> | I–IV            |
| Climatic Classification                                     | 55/100/21             |                 |
| Pollution Degree (DIN VDE 0110/1.89)                        | 2                     |                 |
| Comparative Tracking Index                                  | 175                   |                 |

| Symbol                | Parameter  | Value            | Unit              |
|-----------------------|--|------------------|-------------------|
| $V_{PR}$              | Input–to–Output Test Voltage, Method A, $V_{IORM} \times 1.6 = V_{PR}$ , Type and Sample Test with $t_m$ = 10 s, Partial Discharge < 5 pC  | 1360             | $V_{ m peak}$     |
|                       | Input–to–Output Test Voltage, Method B, $V_{IORM} \times 1.875 = V_{PR}$ , 100% Production Test with $t_m = 1$ s, Partial Discharge < 5 pC | 1594             | $V_{ m peak}$     |
| V <sub>IORM</sub>     | Maximum Working Insulation Voltage   | 850              | V <sub>peak</sub> |
| V <sub>IOTM</sub>     | Highest Allowable Over-Voltage   | 6000             | $V_{peak}$        |
|                       | External Creepage  | ≥7               | mm                |
|                       | External Clearance   | ≥7               | mm                |
|                       | External Clearance (for Option TV, 0.4" Lead Spacing)  | ≥10              | mm                |
| DTI                   | Distance Through Insulation (Insulation Thickness)   | ≥0.5             | mm                |
| T <sub>S</sub>        | Case Temperature (Note 1)  | 175              | °C                |
| I <sub>S,INPUT</sub>  | Input Current (Note 1)   | 350              | mA                |
| P <sub>S,OUTPUT</sub> | Output Power (Note 1)  | 800              | mW                |
| R <sub>IO</sub>       | Insulation Resistance at T <sub>S</sub> , V <sub>IO</sub> = 500 V (Note 1)   | >10 <sup>9</sup> | Ω                 |

<sup>1.</sup> Safety limit values – maximum values allowed in the event of a failure.

### **ABSOLUTE MAXIMUM RATINGS**

| Symbol              | Parameter  | Value              | Unit  |
|---------------------|--|--------------------|-------|
| OTAL DEV            | ICE  |                    |       |
| T <sub>STG</sub>    | Storage Temperature                                    | -40 to +125        | °C    |
| T <sub>OPR</sub>    | Operating Temperature                                  | -40 to +100        | °C    |
| TJ                  | Junction Temperature                                   | -40 to +125        | °C    |
| T <sub>SOL</sub>    | Lead Solder Temperature                                | 260 for 10 seconds | °C    |
| P <sub>D</sub>      | Total Device Power Dissipation @ T <sub>A</sub> = 25°C | 270                | mW    |
|                     | Derate Above 25°C                                      | 3.3                | mW/°C |
| MITTER              |  |                    |       |
| IF                  | Continuous Forward Current                             | 80                 | mA    |
| V <sub>R</sub>      | Reverse Voltage  | 3                  | V     |
| I <sub>F</sub> (pk) | Forward Current – Peak (300 μs, 2% Duty Cycle)         | 3.0                | Α     |
| P <sub>D</sub>      | LED Power Dissipation @ T <sub>A</sub> = 25°C          | 120                | mW    |
|                     | Derate Above 25°C                                      | 2.0                | mW/°C |
| ETECTOR             |  |                    |       |
| BV <sub>CEO</sub>   | Collector-Emitter Breakdown Voltage                    | 30                 | V     |
| BV <sub>CBO</sub>   | Collector-Base Breakdown Voltage                       | 30                 | V     |
| BV <sub>ECO</sub>   | Emitter-Collector Breakdown Voltage                    | 5                  | V     |
| P <sub>D</sub>      | Detector Power Dissipation @ T <sub>A</sub> = 25°C     | 150                | mW    |
|                     | Derate Above 25°C                                      | 2.0                | mW/°C |
| I <sub>C</sub>      | Continuous Collector Current                           | 150                | mA    |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

### **ELECTRICAL CHARACTERISTICS - INDIVIDUAL COMPONENT CHARACTERISTICS**

(T<sub>A</sub> = 25°C unless otherwise noted)

| Symbol            | Parameter                                    | Test Conditions                             | Device             | Min | Тур   | Max | Unit |
|-------------------|--|---|--------------------|-----|-------|-----|------|
| EMITTER           |  |   |                    |     |       |     |      |
| V <sub>F</sub>    | Input Forward Voltage (Note 2)               | I <sub>F</sub> = 10 mA                      | 4NXXM              | -   | 1.2   | 1.5 | V    |
|                   |  |   | H11B1M,<br>TIL113M | 0.8 | 1.2   | 1.5 | ٧    |
| I <sub>R</sub>    | Reverse Leakage Current (Note 2)             | V <sub>R</sub> = 3.0 V                      | 4NXXM              | -   | 0.001 | 100 | μΑ   |
|                   |  | VR = 6.0 V                                  | H11B1M,<br>TIL113M | -   | 0.001 | 10  | μΑ   |
| С                 | Capacitance (Note 2)                         | V <sub>F</sub> = 0 V, f = 1.0 MHz           | All                | -   | 150   | -   | pF   |
| DETECTOR          |  |   |                    |     |       |     |      |
| BV <sub>CEO</sub> | Collector-Emitter Breakdown Voltage (Note 2) | $I_C = 1.0 \text{ mA}, I_B = 0$             | 4NXXM,<br>TIL113M  | 30  | 60    | -   | ٧    |
|                   |  |   | H11B1M             | 25  | 60    | -   | V    |
| BV <sub>CBO</sub> | Collector-Base Breakdown Voltage (Note 2)    | $I_C = 100 \mu A, I_E = 0$                  | All                | 30  | 100   | -   | ٧    |
| BV <sub>ECO</sub> | Emitter-Collector Breakdown Voltage          | I <sub>E</sub> = 100 μA, I <sub>B</sub> = 0 | 4NXXM              | 5.0 | 10    | -   | V    |
|                   | (Note 2)                                     |   | H11B1M,<br>TIL113M | 7   | 10    | -   | V    |
| I <sub>CEO</sub>  | Collector-Emitter Dark Current (Note 2)      | V <sub>CE</sub> = 10 V, Base Open           | All                | -   | 1     | 100 | nA   |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Indicates JEDEC registered data.

### ELECTRICAL CHARACTERISTICS - TRANSFER CHARACTERISTICS (TA = 25°C unless otherwise noted)

| Symbol                | Parameter  | Test Conditions  | Device                      | Min      | Тур | Max  | Unit   |
|-----------------------|--|--|-----------------------------|----------|-----|------|--------|
| C CHARAC              | CTERISTICS   |  |                             | •        |     | •    |        |
| I <sub>C(CTR)</sub>   | Collector Output Current<br>(Note 3) (Note 4) (Note 5) | $I_F = 10 \text{ mA}, V_{CE} = 10 \text{ V},$<br>$I_B = 0$           | 4N32M,<br>4N33M             | 50 (500) | -   | _    | mA (%) |
|                       |  |  | 4N29M,<br>4N30M             | 10 (100) | _   | _    | mA (%) |
|                       |  | I <sub>F</sub> = 1 mA, V <sub>CE</sub> = 5 V                         | H11B1M                      | 5 (500)  | -   | -    | mA (%) |
|                       |  | I <sub>F</sub> = 10 mA, V <sub>CE</sub> = 1 V                        | TIL113M                     | 30 (300) | -   | -    | mA (%) |
| V <sub>CE (SAT)</sub> | Saturation Voltage (Note 3) (Note 5)                   | I <sub>F</sub> = 8 mA, I <sub>C</sub> = 2.0 mA                       | 4NXXM                       | -        | -   | 1.0  | V      |
|                       |  |  | TIL113M                     | -        | -   | 1.25 | V      |
|                       |  | I <sub>F</sub> = 1 mA, I <sub>C</sub> = 1 mA                         | H11B1M                      | -        | -   | 1.0  | V      |
| C CHARAC              | CTERISTIC  |  |                             |          |     |      |        |
| t <sub>ON</sub>       | Turn-on Time   | $I_F$ = 200 mA, $I_C$ = 50 mA, $V_{CC}$ = 10 V, $R_L$ = 100 $\Omega$ | 4NXXM,<br>TIL113M           | -        | -   | 5.0  | μs     |
|                       |  | $I_F$ = 10 mA, $V_{CE}$ = 10 V, $R_L$ = 100 $\Omega$                 | H11B1M                      | -        | 25  | -    | μs     |
| t <sub>OFF</sub>      | Turn-off Time  | $I_F$ = 200 mA, $I_C$ = 50 mA, $V_{CC}$ = 10 V, $R_L$ = 100 $\Omega$ | 4N32M,<br>4N33M,<br>TIL113M | -        | -   | 100  | μs     |
|                       |  |  | 4N29M,<br>4N30M             | -        | -   | 40   | μs     |
|                       |  | $I_F$ = 10 mA, $V_{CE}$ = 10 V, $R_L$ = 100 $\Omega$                 | H11B1M                      | -        | 18  | _    | μs     |
| BW                    | Bandwidth (Note 6) (Note 7)                            |  |                             | -        | 30  | -    | kHz    |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

- 3. Indicates JEDEC registered data.
- 4. The current transfer ratio  $(I_C/I_F)$  is the ratio of the detector collector current to the LED input current.
- 5. Pulse test: pulse width =  $300 \,\mu\text{s}$ , duty cycle  $\leq 2.0\%$ .
- 6.  $I_F$  adjusted to  $I_C$  = 2.0 mA and  $I_C$  = 0.7 mA rms.
- 7. The frequency at which I<sub>C</sub> is 3 dB down from the 1 kHz value.

### ELECTRICAL CHARACTERISTICS - ISOLATION CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted)

| Symbol           | Parameter                      | Test Conditions   | Min              | Тур | Max | Unit               |
|------------------|--------------------------------|---|------------------|-----|-----|--------------------|
| V <sub>ISO</sub> | Input-Output Isolation Voltage | t = 1 Minute  | 4170             | -   | -   | VAC <sub>RMS</sub> |
| C <sub>ISO</sub> | Isolation Capacitance          | V <sub>I-O</sub> = 0 V, f = 1 MHz                         | _                | 0.2 | ı   | pF                 |
| R <sub>ISO</sub> | Isolation Resistance           | $V_{I-O} = \pm 500 \text{ VDC}, T_A = 25^{\circ}\text{C}$ | 10 <sup>11</sup> | -   | -   | Ω                  |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

### **TYPICAL PERFORMANCE CURVES**

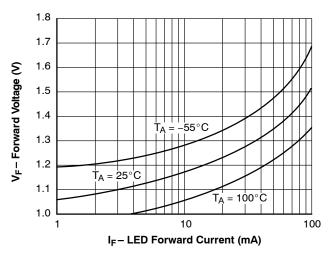


Figure 1. LED Forward Voltage vs. Forward Current

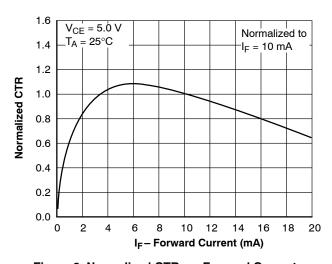


Figure 2. Normalized CTR vs. Forward Current

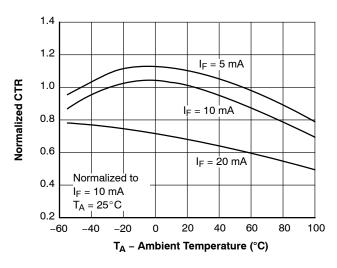


Figure 3. Normalized CTR vs. Ambient Temperature

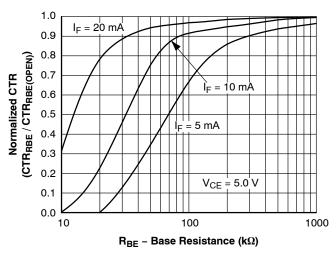


Figure 4. CTR vs. RBE (Unsaturated)

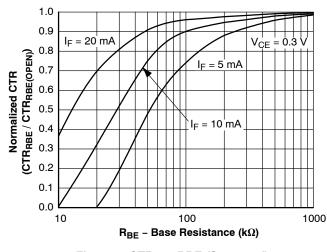


Figure 5. CTR vs. RBE (Saturated)

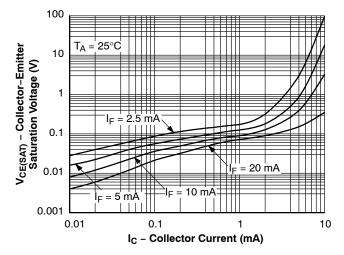
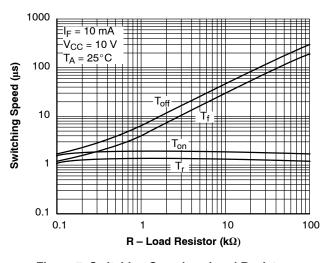


Figure 6. Collector-Emitter Saturation Voltage vs. Collector Current

### TYPICAL PERFORMANCE CURVES (continued)

5.0

4.5



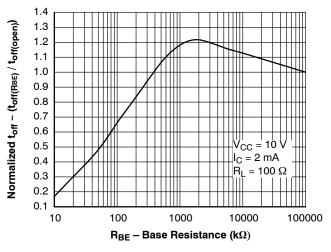
Normalized ton - (ton(RBE) / ton(open) 4.0 3.5 3.0 2.5 2.0 1.5 1.0 0.5 10 100 1000 10000 100000

I<sub>C</sub> = 2 mA

Figure 7. Switching Speed vs. Load Resistor

Figure 8. Normalized ton vs. RBE

 $R_{BE}$  – Base Resistance (k $\Omega$ )



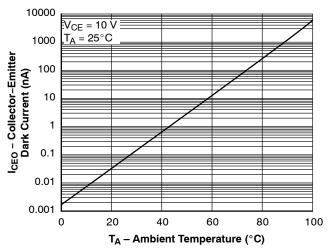


Figure 9. Normalized toff vs. RBE

Figure 10. Dark Current vs. Ambient Temperature

### SWITCHING TIME TEST CIRCUIT AND WAVEFORMS

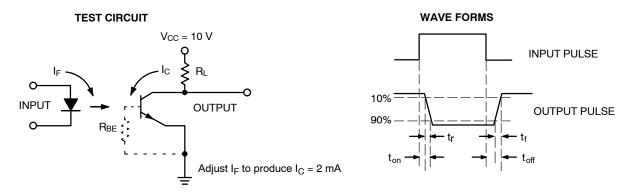


Figure 11. Switching Time Test Circuit and Waveforms

### **REFLOW PROFILE**

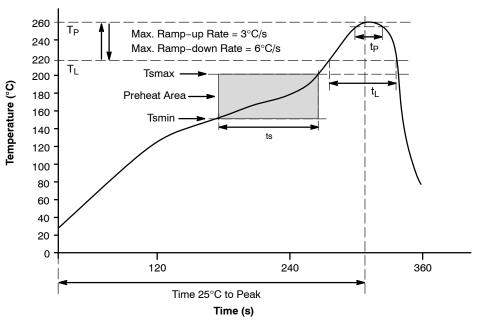


Figure 12. Reflow Profile

### **REFLOW PROFILE**

| Profile Feature   | Pb-Free Assembly Profile |
|---|--------------------------|
| Temperature Min. (Tsmin)                                  | 150°C                    |
| Temperature Max. (Tsmax)                                  | 200°C                    |
| Time (t <sub>S</sub> ) from (Tsmin to Tsmax)              | 60–120 s                 |
| Ramp-up Rate (t <sub>L</sub> to t <sub>P</sub> )          | 3°C/s max.               |
| Liquidous Temperature (T <sub>L</sub> )                   | 217°C                    |
| Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> ) | 60–150 s                 |
| Peak Body Package Temperature                             | 260°C +0°C / -5°C        |
| Time (t <sub>P</sub> ) within 5°C of 260°C                | 30 s                     |
| Ramp-down Rate (T <sub>P</sub> to T <sub>L</sub> )        | 6°C/s max.               |
| Time 25°C to Peak Temperature                             | 8 min max.               |

### **ORDERING INFORMATION**

| Part Number | Package  | Packing Method <sup>†</sup> |
|-------------|--|-----------------------------|
| 4N29M       | DIP 6-Pin  | 50 Units / Tube             |
| 4N29SM      | SMT 6-Pin (Lead Bend)                                    | 50 Units / Tube             |
| 4N29SR2M    | SMT 6-Pin (Lead Bend)                                    | 1000 / Tape & Reel          |
| 4N29VM      | DIP 6-Pin, DIN EN/IEC60747-5-5 Option                    | 50 Units / Tube             |
| 4N29SVM     | SMT 6-Pin (Lead Bend), DIN EN/IEC60747-5-5 Option        | 50 Units / Tube             |
| 4N29SR2VM   | SMT 6-Pin (Lead Bend), DIN EN/IEC60747-5-5 Option        | 1000 / Tape & Reel          |
| 4N29TVM     | DIP 6-Pin, 0.4" Lead Spacing, DIN EN/IEC60747-5-5 Option | 50 Units / Tube             |

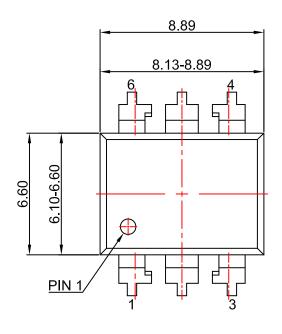
<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

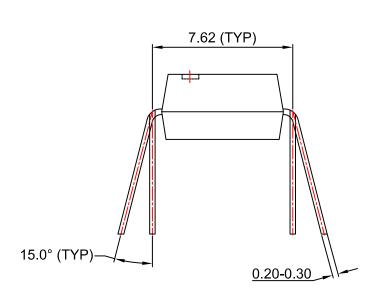
8. The product orderable part number system listed in this table also applies to the 4N30M, 4N32M, 4N33M, H11B1M and TIL113M devices.

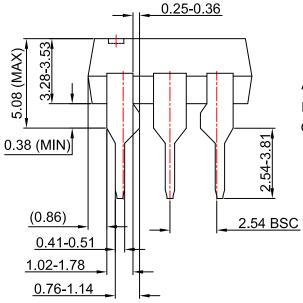


### PDIP6 8.51x6.35, 2.54P CASE 646BX ISSUE O

**DATE 31 JUL 2016** 







### NOTES:

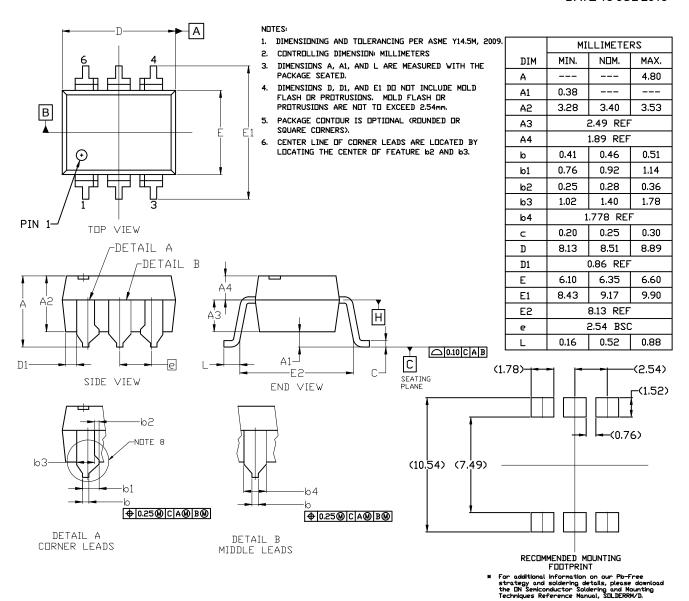
- A) NO STANDARD APPLIES TO THIS PACKAGE.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSION

| DOCUMENT NUMBER: | 98AON13449G            | Electronic versions are uncontrolled except when accessed directly from the Document Repos<br>Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. |             |  |  |
|------------------|------------------------|---|-------------|--|--|
| DESCRIPTION:     | PDIP6 8.51X6.35, 2.54P |   | PAGE 1 OF 1 |  |  |

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

### PDIP6 8.51x6.35, 2.54P CASE 646BY ISSUE A

**DATE 15 JUL 2019** 

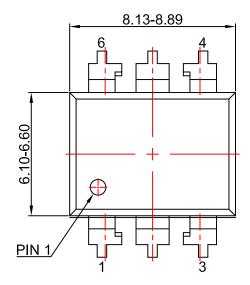


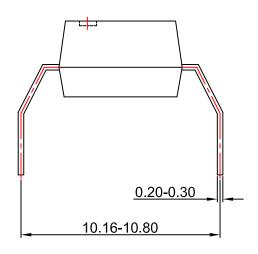
| DOCUMENT NUMBER: | 98AON13450G            | Electronic versions are uncontrolled except when accessed directly from Printed versions are uncontrolled except when stamped "CONTROLLED" |             |
|------------------|------------------------|--|-------------|
| DESCRIPTION:     | PDIP6 8.51x6.35, 2.54P |  | PAGE 1 OF 1 |

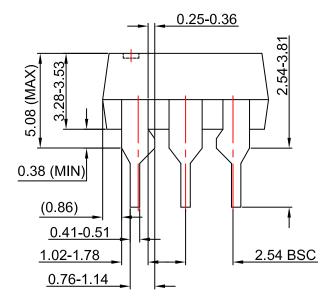
ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

### PDIP6 8.51x6.35, 2.54P CASE 646BZ ISSUE O

**DATE 31 JUL 2016** 







### NOTES:

- A) NO STANDARD APPLIES TO THIS PACKAGE.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSION

| DOCUMENT NUMBER: | 98AON13451G            | Electronic versions are uncontrolled except when accessed directly from the Document Repos<br>Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. |             |  |  |
|------------------|------------------------|---|-------------|--|--|
| DESCRIPTION:     | PDIP6 8.51X6.35, 2.54P |   | PAGE 1 OF 1 |  |  |

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI., and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <a href="www.onsemi.com/site/pdf/Patent-Marking.pdf">www.onsemi.com/site/pdf/Patent-Marking.pdf</a>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems. or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

 $\textbf{Technical Library:} \ \underline{www.onsemi.com/design/resources/technical-documentation}$ 

onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at

www.onsemi.com/support/sales